

Continental Device India Limited

An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company





NPN SILICON PLANAR EPITAXIAL DARLINGTON TRANSISTOR

BC517



TO-92 Plastic Package

ABSOLUTE MAXIMUM RATINGS (T_a=25°C)

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Emitter Voltage	V _{CES}	30	V
Collector Base Voltage	V _{CBO}	40	V
Emitter Base Voltage	V _{EBO}	10	V
Collector Current Continuous	I _C	1.0	Α
Power Dissipation at T _a =25°C	P _D	625	mW
Derate Above 25°C		12	mW/ºC
Power Dissipation at T _c =25°C	P _D	1.5	W
Derate Above 25°C		12	mW/ºC
Operating And Storage Junction Temperature Range	T _j , T _{stg}	- 55 to +150	°C

THERMAL RESISTANCE

Junction to Ambient in free air	R _{th (j-a)}	200	°C/W
Junction to Case	R _{th (j-c)}	83.3	°C/W

ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Emitter Voltage	V_{CES}	$I_C=2mA$, $V_{BE}=0$	30			V
Collector Base Voltage	V_{CBO}	I _C =10μΑ, I _E =0	40			V
Emitter Base Voltage	V_{EBO}	I _E =100uA, I _C =0	10			V
Collector Cut Off Current	I _{CES}	V_{CE} =30V, V_{BE} =0			500	nA
Collector Cut Off Current	I _{CBO}	V_{CB} =30 V , I_E =0			100	nA
Emitter Cut Off Current	I _{EBO}	V_{EB} =10V, I_{C} =0			100	nA
DC Current Gain	*h _{FE}	$I_C=20mA$, $V_{CE}=10V$	30,000			
Collector Emitter Saturation Voltage	*V _{CE (sat)}	$I_C=100$ mA, $I_B=0.1$ mA			1.0	٧
Base Emitter On Voltage	*V _{BE (on)}	I _C =10mA, V _{CE} =5V			1.4	V

SMALL SIGNAL CHARACTERISTICS

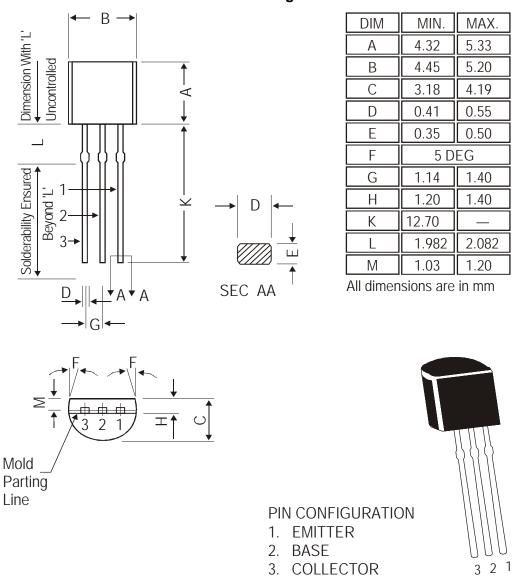
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Current Gain - Bandwidth product	**f _T	I _C =10mA, V _{CE} =5V, f=100MHz		200		MHz

*Pulse Test: Pulse Width ≤ 2%

** $f_T = |h_{fe}|$ * f_{test} BC517Rev_3 250612

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The TO-92 Package, Tape and Ammo Pack drawings are correct as on the date of issue/revision of this Data Sheet.

The currently valild dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

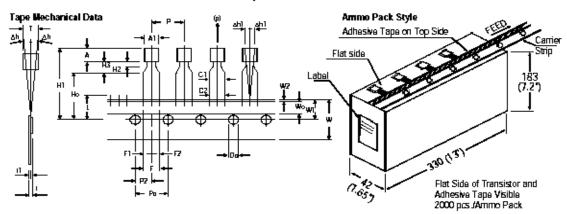
Packing Details

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

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TO-92 Tape and Ammo Pack



All dimensions are in mm

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		SPECIFICATION				
ПЕМ	SYMBOL	MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.45		5.20		MOTES
BODY HEIGHT	A	4.32		5.33		Maximum alignment dev
BODY THICKNESS	Т	3.18		4.19		leads will not to be great
PITCH OF COMPONENT	P		12.7		± 1.0	2. Maximum non-cumulativ
*1FEED HOLE PITCH	Po		12.7		± 0.3	between tape feed holes
*2 FEED HOLE CENTRE TO			l			exceed 1 mm in 20 pitch
COMPONENT CENTRE	P2		6.35		± 0.4	Holddown tape will not e
DISTANCE BETWEEN OUTER LEADS	F		5.0B		+ 0.6 - 0.2	the edge(s) of carrier tag
			3.00		- 0.2	shall be no exposure of
*3 COMPONENT ALIGNMENT SIDE VIEW	Δh		0	1.0		4. There will be no more th
*4 COMPONENT ALIGNMENT FRONT VIEW	∆h1		0	1.3		consecutive missing con tape.
TAPE WIDTH	W		18		± 0.5	'
HOLD-DOWN TAPE WIDTH	₩o		6		± 0.2	A tape trailer, having at l holes are provided after
HOLE POSITION	W1		9		+ 0.7	component in a tape.
LIGHT DOWN TARE POPULAR				,	- 0.5	6. Splices should not interf
HOLD-DOWN TAPE POSITION	W2	0.0	16	0.7		sprocket feed holes.
LEAD WIRE CLINCH HEIGHT	Ho		16	24.0	± 0.5	'
COMPONENT HEIGHT LENGTH OF SNIPPED LEADS	H1 L			11.0		
FEED HOLE DIAMETER	Do		4	11.0	± 0.2	
*5 TOTAL TAPE THICKNESS	1		*	1.2	10.2	REMARKS
LEAD - TO - LEAD DISTANCE	F1, F2	2.40		2.70		*1 Cumulative pitch error 1
	· ·				- 0.1	*2 To be measured at botto
STAND OFF	H2	0.45		1.45		*3 At top of body
CLINCH HEIGHT	H3			3.0		*4 At top of body
LEAD PARALLELISM	[C1 - C2]			0.22		
PULL - OUT FORCE	(p)	6N				*5 t1 0,3 = 0,6 mm

- neewted nottsive ater than 0.2mm.
- ive variation as shall not thes.
- exceed beyond ape and there f adhesive.
- than three (3) omponents in a
- least three feed the last
- rfere with the
- 1.0 mm/20 pitch
- tom of clinch

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

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Customer Notes BC517

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Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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